

# RS2A THRU RS2M

2.0 AMPS. Fast Recovery Surface Mount Rectifiers



Voltage Range 50 to1000 Volts Current 2.0 Amperes

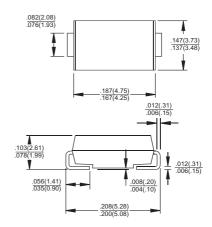
## **Features**

- ♦ For surface mounted application
- ♦ Glass passivated junction chip
- Built-in strain relief, ideal for automated placement
- Plastic material used carries Underwriters Laboratory Classification 94V-O
- ♦ Fast switching for high efficiency
- → High temperature soldering:
  260°C/10 seconds at terminals

# **Mechanical Data**

- ♦ Cases: Molded plastic♦ Terminals: Solder plated
- ♦ Polarity: Indicated by cathode band
- ♦ Packing: 12mm tape per E1A STD RS-481
- ♦ Weight: 0.093 gram

#### SMB/DO-214AA



Dimensions in inches and (millimeters)

# Maximum Ratings and Electrical Characteristics

Rating at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load.

For capacitive load, derate current by 20%

Type Number	Symbol	RS 2A	RS 2B	RS 2D	RS 2G	RS 2J	RS 2K	RS 2M	Units
Maximum Recurrent Peak Reverse Voltage	V <sub>RRM</sub>	50	100	200	400	600	800	1000	V
Maximum RMS Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage	$V_{DC}$	50	100	200	400	600	800	1000	V
Maximum Average Forward Rectified Current See Fig. 1 @T <sub>L</sub> =100°C	I <sub>(AV)</sub>	2.0							Α
Peak Forward Surge Current, 8.3 ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I <sub>FSM</sub>	50							Α
Maximum Instantaneous Forward Voltage @ 2.0A	V <sub>F</sub>	1.3							V
Maximum DC Reverse Current @ T <sub>A</sub> =25℃ at Rated DC Blocking Voltage @ T <sub>A</sub> =125℃	I <sub>R</sub>	5 200							uA uA
Maximum Reverse Recovery Time ( Note 1 )	Trr	150 250 500					nS		
Typical Junction Capacitance ( Note 2 )	Cj	50							pF
Typical Thermal Resistance (Note 3)	$R \theta JA$	55.0							°C/W
	R $\theta$ JL	18.0							°C/W
Operating Temperature Range	TJ	-55 to +150							${\mathbb C}$
Storage Temperature Range	Тѕтс	-55 to +150							${\mathbb C}$

Notes: 1. Reverse Recovery Test Conditions: I<sub>F</sub>=0.5A, I<sub>R</sub>=1.0A, I<sub>RR</sub>=0.25A

- 2. Measured at 1 MHz and Applied V<sub>R</sub>=4.0 Volts
- 3. Thermal Resistance from Junction to Ambient and Junction to Lead Mounted on P.C.B. with 0.27"x0.27" (  $7.0 \times 7.0 \text{ mm}$  ) Copper Pad Areas.

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### RATINGS AND CHARACTERISTIC CURVES (RS2A THRU RS2M)

FIG.1- MAXIMUM FORWARD CURRENT DERATING CURVE RESISTIVE OR AVERAGE FORWARD CURRENT. (A) INDUCTIVE LOAD 1.0 P.C.B. MOUNTED 0.27 X 0.27" (7.0X7.0mm) COPPER PAD AREAS 0.5 130 150 50 60 70 80 100 110 120 140 160 LEAD TEMPERATURE. (°C)

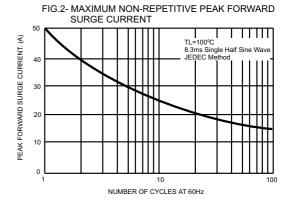
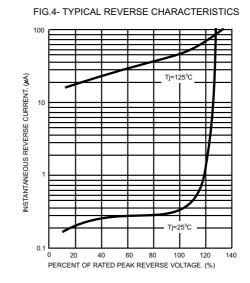


FIG.3- TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

20
10
10
Pulse Width=300 µs
1% Duty Cycle
1% Duty Cycle
1 Tj=25 °C



FORWARD VOLTAGE. (V)
FIG.5- TYPICAL JUNCTION CAPACITANCE

